

DATA SHEET

HIGH VOLTAGE AND ANTI-SULFURATED CHIP RESISTORS

> AH series 0.5%, 1%, 5% sizes 0603/0805/1206

RoHS compliant

IEC 62368-I Safety Certificate issued by UL Demko: sizes 0603/0805/1206









Chip Resistor Surface Mount

AH SERIES

0603/0805/1206 (RoHS Compliant)

SCOPE

This specification describes AH0603/0805/1206 high voltage and anti-sulfurated chip resistors with lead-free terminations made by thick film process.

<u>APPLICATIONS</u>

- Converter
- Printer equipment
- Battery charger
- Computer
- Power supply
- Car electronics

<u>FEATUR</u>ES

- · AEC-Q200 qualified
- RoHS compliant
- Reducing environmentally hazardous wastes
- High component and equipment reliability
- Non-forbidden materials used in products/production
- Halogen Free Epoxy
- Moisture sensitivity level: MSL I
- IEC 62368-1:2014 safety certificate (G.10.2) issued by UL Demko for the following sizes and resistance ranges:

- 0603: $100K\Omega$ to $10M\Omega$

- 0805: $100K\Omega$ to $22M\Omega$

- 1206: $100K\Omega$ to $27M\Omega$

*Please refer to UL certification

ORDERING INFORMATION - GLOBAL PART NUMBER & 12NC

Both part numbers are identified by the series, size, tolerance, packing type, temperature coefficient, taping reel and resistance value.

YAGEO BRAND ordering code

GLOBAL PART NUMBER (PREFERRED)

AH XXXX X X X XX XXXX L

(1) (2) (3) (4) (5) (6) (7)

(I) SIZE

0603/0805/1206

(2) TOLERANCE

 $D = \pm 0.5\%$

 $F = \pm 1\%$

 $J = \pm 5\%$

(3) PACKAGING TYPE

R = Paper/PE taping reel

K = Embossed taping reel

(4) TEMPERATURE COEFFICIENT OF RESISTANCE

- = Base on spec

(5) TAPING REEL

07= 7 inch dia. Reel

(6) RESISTANCE VALUE

There are $2\sim4$ digits indicated the resistor value. Letter R/K/M is decimal point, no need to mention the last zero after R/K/M, e.g. I K2, not I K20.

Detailed resistance rules show in table of "Resistance rule of global part number".

(7) DEFAULT CODE

Letter L is system default code for ordering only (Note)

Resistance rule of global part number

Resistance code ru	le Example
XXKX	ΙΟΚ = ΙΟ,000 Ω
$(10 \text{ to } 97.6 \text{ K}\Omega)$	97K6 = 97,600 Ω
XXXK	$100K = 100,000\Omega$
(100 to 976 KΩ)	$976K = 976,000\Omega$
XMXX	$IM = 1,000,000 \Omega$
(1 to 9.76 MΩ)	$9M76 = 9,760,000 \Omega$
XXMX	$10M = 10,000,000 \Omega$
(10 to 16 MΩ)	$27M = 27,000,000 \Omega$

ORDERING EXAMPLE

The ordering code of a AHI206 chip resistor, value I $M\Omega$ with $\pm 5\%$ tolerance, supplied in 7-inch tape reel is: AHI206JR-07IML.

NOTE

- All our R-Chip products meet RoHS compliant. "LFP" of the internal 2D reel label mentions "Lead Free Process"
- On customized label, "LFP" or specific symbol printed and the optional "L" at the end of GLOBAL PART NUMBER / 12NC can be added (both are on customer request)



MARKING

AH0603/0805/1206



E-24 series: 3 digits, ±5%

First two digits for significant figure and 3rd digit for number of zeros

AH0603



E-24 series: 3 digits, ±0.5% & ±1%

Exception values 10/11/13/15/20/75 of E24 series

One short bar under marking letter



E-96 series: 3 digits, ±0.5% & ±1%

Including values 10/11/13/15/20/75 of E24 series

First two digits for E-96 marking rule and 3rd letter for number of zeros

AH0805/1206



Both E-24 and E-96 series: 4 digits, ±0.5% & ±1%

First three digits for significant figure and 4th digit for number of zeros

For further marking information, please refer to data sheet "Chip resistors marking".

CONSTRUCTION

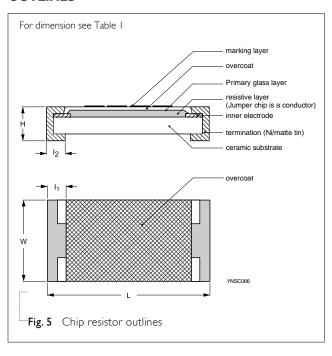
The resistor is constructed on top of a high-grade ceramic body. Internal metal electrodes are added on each end to make the contacts to the thick film resistive element. The composition of the resistive element is a noble metal imbedded into a glass and covered by a second glass to prevent environment influences. The resistor is laser trimmed to the rated resistance value. The resistor is covered with a protective epoxy coat, finally the two external terminations (matte tin on Nibarrier) are added. See fig.5

DIMENSIONS

Table I For outlines see fig. 5

TYPE	L (mm)	W (mm)	H (mm)	I _I (mm)	I ₂ (mm)
AH0603	1.60 ±0.10	0.80 ±0.10	0.45 ±0.10	0.25 ±0.15	0.25 ±0.15
AH0805	2.00 ±0.10	1.25 ±0.10	0.50 ±0.10	0.35 ±0.20	0.35 ±0.20
AH1206	3.10 ±0.10	1.60 ±0.10	0.55 ±0.10	0.45 ±0.20	0.45 ±0.20

OUTLINES





Chip Resistor Surface Mount AH SER

ELECTRICAL CHARACTERISTICS

Table 2

			CHARACTERISTICS				
TYPE	RESISTANCE RANGE	Rated Power	Operating Temperature Range	Max. Working Voltage	Max. Overload Voltage	Dielectric Withstanding Voltage	Temperature Coefficient of Resistance
AH0603	5% (E-24) 47Ω to $10M\Omega$ 1% (E-24/E-96) 47Ω to $10M\Omega$ 0.5% (E-24/E-96) 47Ω to $10M\Omega$	1/10W	_	350V	500V	500V	
AH0805	5% (E-24) 47Ω to $22M\Omega$ 1% (E-24/E-96) 47Ω to $22M\Omega$ 0.5% (E-24/E-96) 47Ω to $10M\Omega$	1/8 W	–55 °C to +155 °C	400 V	800 V	800 V	±200 ppm/°C
AH1206	5% (E-24) 47Ω to $27M\Omega$ I% (E-24/E-96) 47Ω to $27M\Omega$ 0.5% (E-24/E-96) 47Ω to $15M\Omega$	1/4 W		800 V	1,600 V	1,600 V	

FOOTPRINT AND SOLDERING PROFILES

For recommended footprint and soldering profiles, please refer to data sheet "Chip resistors mounting".

PACKING STYLE AND PACKAGING QUANTITY

Table 3 Packing style and packaging quantity

PACKING STYLE	reel Dimension	AH 0603	AH 0805	AH 1206
Paper/PE taping reel (R)	7" (178 mm)	5,000	5,000	5,000
Embossed taping reel (K)	7" (178 mm)			

NOTE

1. For Paper/PE/Embossed tape and reel specification/dimensions, please refer to data sheet "Chip resistors packing".

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FUNCTIONAL DESCRIPTION

OPERATING TEMPERATURE RANGE

Range: -55 °C to +155 °C

POWER RATING

Each type rated power at 70 °C:

AH0603=1/10W; AH0805=1/8W; AH1206=1/4W

RATED VOLTAGE

The DC or AC (rms) continuous working voltage corresponding to the rated power is determined by the following formula:

$$V = \sqrt{(P \times R)}$$

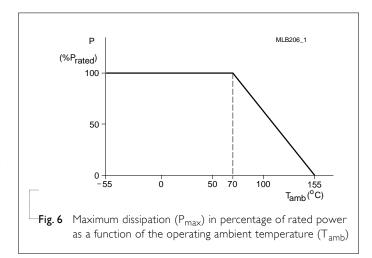
or max. working voltage whichever is less

Where

V = Continuous rated DC or AC (rms) working voltage (V)

P = Rated power (W)

 $R = Resistance value (\Omega)$ Maximum working voltage can be applicable to resistors only if the resistance value is equal to or higher than the critical resistance value.



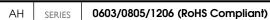


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TESTS AND REQUIREMENTS

Table 4 Test condition, procedure and requirements

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
High Temperature Exposure	AEC-Q200 Test 3 MIL-STD-202 Method 108	1,000 hours at TA = 155 °C, unpowered	±(1.0%+0.05Ω)
Moisture Resistance	AEC-Q200 Test 6 MIL-STD-202 Method 106	Each temperature / humidity cycle is defined at 8 hours (method 106F), 3 cycles / 24 hours for 10d. with 25 °C / 65 °C 95% R.H, without steps 7a & 7b, unpowered	±(2.0%+0.05Ω)
Biased Humidity	AEC-Q200 Test 7 MIL-STD-202 Method 103	1,000 hours; 85 °C / 85% RH 10% of operating power Measurement at 24±4 hours after test conclusion.	±(5.0%+0.05Ω)
Operational Life	AEC-Q200 Test 8 MIL-STD-202 Method 108	1,000 hours at 125 °C, derated voltage applied for 1.5 hours on, 0.5 hour off, still-air required	±(3.0%+0.05Ω)
Resistance to Soldering Heat	AEC-Q200 Test 15 MIL-STD-202 Method 210	Condition B, no pre-heat of samples Lead-free solder, 260±5 °C, 10±1 seconds immersion time Procedure 2 for SMD: devices fluxed and cleaned with isopropanol	±(1.0%+0.05Ω) No visible damage
Thermal Shock	AEC-Q200 Test 16 MIL-STD-202 Method 107	-55/+125 °C Number of cycles is 300. Devices mounted Maximum transfer time is 20 seconds. Dwell time is 15 minutes. Air – Air	±(1.0%+0.05Ω)
ESD	AEC-Q200 Test 17 AEC-Q200-002	Human Body Model, I pos. + I neg. discharges 0201: 500V 0402/0603: IKV 0805 and above: 2KV	±(4.0%+0.05Ω)



YAGEO				
	Chip	Resistor	Surface	

ce Mount	AH	SERIES	
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TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Solderability - Wetting	AEC-Q200 Test 18 J-STD-002	Electrical Test not required Magnification 50X SMD conditions:	Well tinned (≥95% covered) No visible damage
		(a) Method B, aging 4 hours at 155 °C dry heat, dipping at 235±3 °C for 5±0.5 seconds.	140 VISIDIC GAITTAGE
		(b) Method B, steam aging 8 hours, dipping at $215\pm3~^{\circ}\text{C}$ for 5 ± 0.5 seconds.	
		(c) Method D, steam aging 8 hours, dipping at 260 ± 3 °C for 30 ± 0.5 seconds.	
Board Flex	AEC-Q200 Test 21 AEC-Q200-005	Chips mounted on a 90mm glass epoxy resin PCB (FR4)	±(1.0%+0.05Ω)
		Bending for 0201/0402: 5 mm 0603/0805: 3 mm 1206 and above: 2 mm	
		Holding time: minimum 60 seconds	
Temperature Coefficient of Resistance (T.C.R.)	MIL-STD-202 Method 304	At +25/–55 °C and +25/+125 °C	Refer to table 2
		Formula:	
		T.C.R= $\frac{R_2-R_1}{R_1(t_2-t_1)} \times 10^6 \text{ (ppm/°C)}$	
		Where	
		t ₁ =+25 °C or specified room temperature	
		t_2 =-55 °C or +125 °C test temperature	
		R_1 =resistance at reference temperature in ohms R_2 =resistance at test temperature in ohms	
Short Time	IEC60115-1 4.13	2.5 times of rated voltage or maximum	±(2.0%+0.05Ω)
Overload	1200113-1 7.13	overload voltage whichever is less for 5 sec at room temperature	±(2.070 · 0.03 1 2)
FOS	ASTM-B-809-95* * Modified	Sulfur 750 hours, 105°C, unpowered	±(4.0%+0.05Ω)



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REVISION HISTORY

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version I	Aug. 03, 2022	-	- 12 dimension updated, for size I 206.
Version 0	Sep. 10, 2020	-	- First issue of this specification

[&]quot;YAGEO reserves all the rights for revising the content of this datasheet without further notification, as long as the products itself are unchanged. Any product change will be announced by PCN."